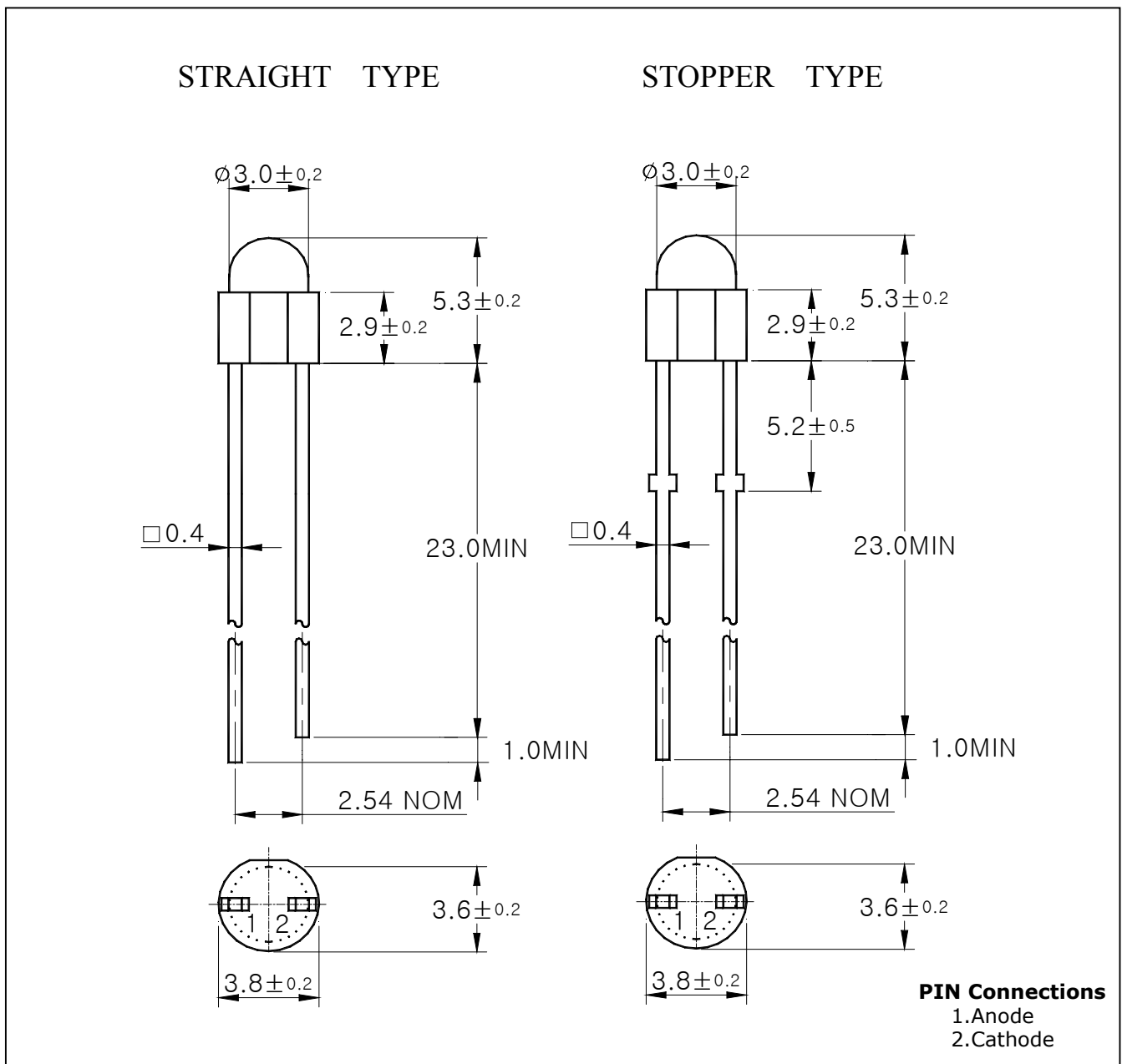


## Features

- Yellow colored transparency lens type
- $\phi 3\text{mm}$ (T-1) all plastic mold type
- Low power consumption

## Outline Dimensions

unit : mm

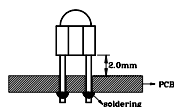


## Absolute maximum ratings

Characteristic	Symbol	Ratings	Unit
Power Dissipation	$P_D$	85	mW
Forward Current	$I_F$	30	mA
* <sup>1</sup> Peak Forward Current	$I_{FP}$	50	mA
Reverse Voltage	$V_R$	4	V
Operating Temperature	$T_{opr}$	-25 ~ 85	°C
Storage Temperature	$T_{stg}$	-30 ~ 100	°C
* <sup>2</sup> Soldering Temperature	$T_{sol}$	260°C for 5 seconds	

\*1. Duty ratio = 1/16, Pulse width = 0.1ms

\*2. Keep the distance more than 2.0mm from PCB to the bottom of LED package



## Electrical Characteristics

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	$V_F$	$I_F = 20\text{mA}$	-	2.0	2.7	V
* <sup>3</sup> Luminous Intensity	$I_V$	$I_F = 20\text{mA}$	27	80	100	mcd
Peak Wavelength	$\lambda_P$	$I_F = 20\text{mA}$	-	585	-	nm
Spectrum Bandwidth	$\Delta \lambda$	$I_F = 20\text{mA}$	-	30	-	nm
Reverse Current	$I_R$	$V_R = 4\text{V}$	-	-	10	uA
* <sup>4</sup> Half angle	$\theta_{1/2}$	$I_F = 20\text{mA}$	-	$\pm 17$	-	deg

\*3. Luminous Intensity Maximum tolerance for each Grade Classification limit is  $\pm 18\%$

\*3. Luminous Intensity classification

I	J	K
24~43	43~68	68~100

\*4.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is 1/2 the peak intensity

## Characteristic Diagrams

Fig. 1  $I_F - V_F$

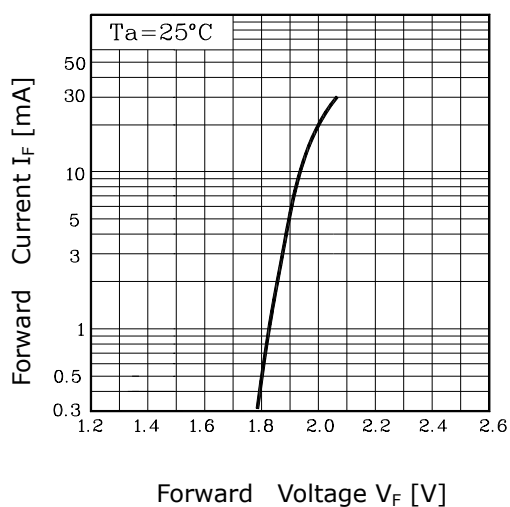


Fig. 2  $I_V - I_F$

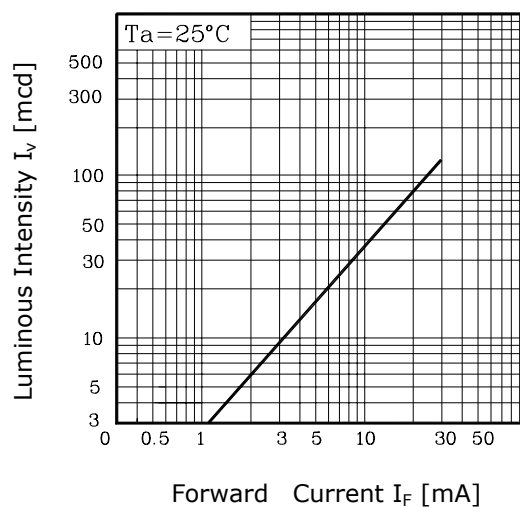


Fig. 3  $I_F - T_a$

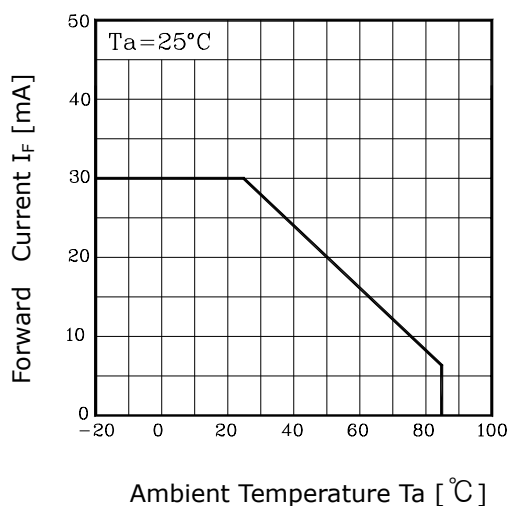


Fig. 4 Spectrum Distribution

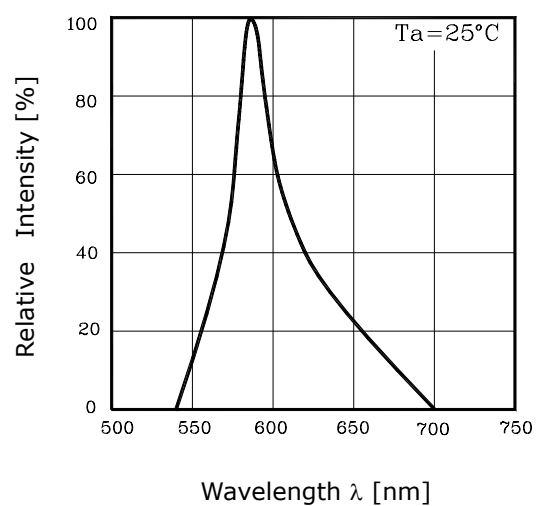


Fig. 5 Radiation Diagram

